N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
40	0.013 at V _{GS} = 10 V	12	15 nC		
	0.015 at V _{GS} = 4.5 V	11	13110		

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Top View

D 8

D

D 6

D

S

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S

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FEATURES

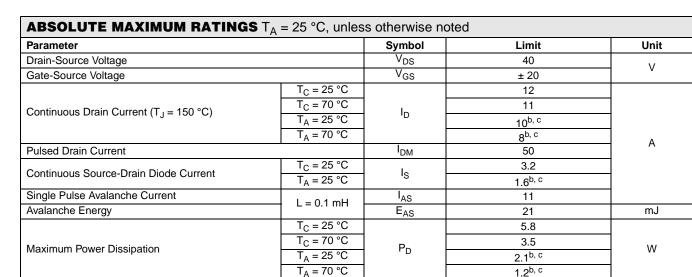
- DT-Trench Power MOSFET
- Optimized for High-Side Synchronous ٠ **Rectifier Operation**
- 100 % R_g Tested
- 100 % UIS Tested •

APPLICATIONS

Notebook CPU Core



- High-Side Switch



THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	39	53	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	25	29	0,00	

T_J, T_{stg}

Notes:

a. Base on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s. d. Maximum under Steady State conditions is 85 °C/W.

Operating Junction and Storage Temperature Range

N-Channel MOSFET

- 55 to 150



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°C

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SPECIFICATIONS $T_J = 25 \ ^{\circ}C$, unless oth	erwise noted					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			-	_	_	_	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		28		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	10 - 200 μΛ		- 6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0		3.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Oata Maltana Durin Original	1	$V_{DS} = 40 V, V_{GS} = 0 V$			1	μA	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			А	
	Б	$V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		0.013	0.015	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 9 \text{ A}$		0.015	0.017		
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 10 A		52		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1341		pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		175			
Reverse Transfer Capacitance	C _{rss}			73			
T (10 (0)		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A		15	23	nC	
Total Gate Charge	Qg			6.8	10.2		
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 10 \text{ A}$		2.5			
Gate-Drain Charge	Q _{gd}			2.3			
Gate Resistance	R _g	f = 1 MHz	0.36	1.8	3.6	Ω	
Turn-On Delay Time	t _{d(on)}			16	24	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.4 Ω		12	18		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D} \cong$ 9 A, V_GEN = 4.5 V, R_g = 1 Ω		16	24		
Fall Time	t _f			10	20		
Turn-On Delay Time	t _{d(on)}			8	16		
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.4 Ω		10	20		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D} \cong$ 9 A, V_GEN = 10 V, R_g = 1 Ω		16	24		
Fall Time	t _f			8	15		
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			12	•	
Pulse Diode Forward Current ^a	I _{SM}				50	A	
Body Diode Voltage	V _{SD}	I _S = 9 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	30	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			6	12	nC	
Reverse Recovery Fall Time	t _a	$I_F = 9 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		8		ns	
Reverse Recovery Rise Time	t _b			7			

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

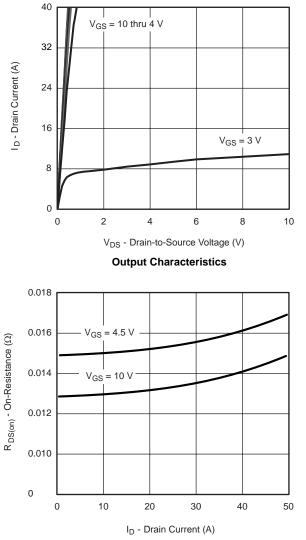
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



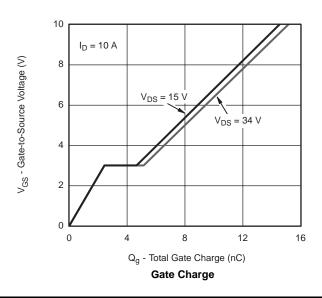
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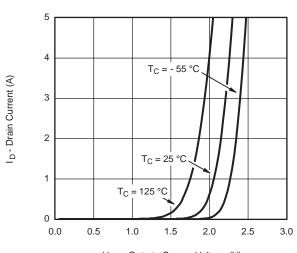
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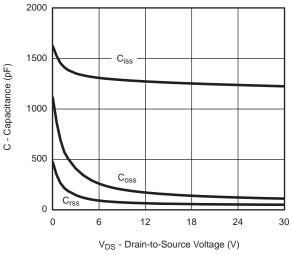


On-Resistance vs. Drain Current and Gate Voltage

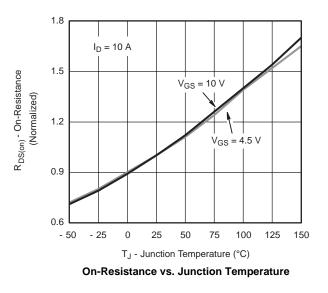




V_{GS} - Gate-to-Source Voltage (V) Transfer Characteristics



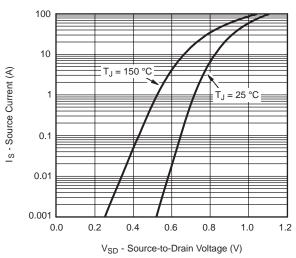
Capacitance



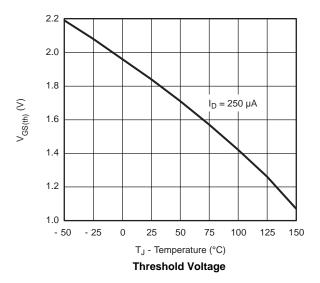
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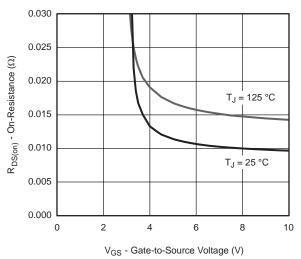
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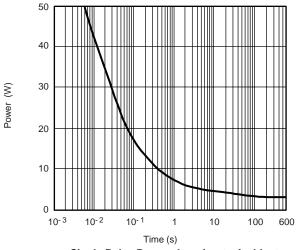




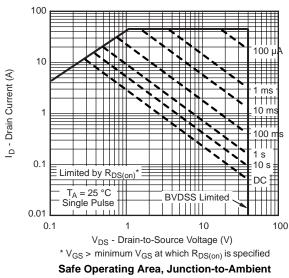




On-Resistance vs. Gate-to-Source Voltage

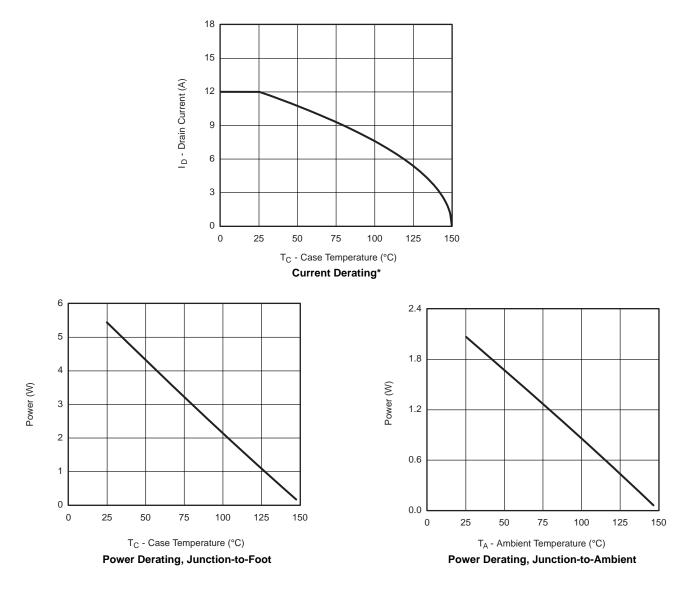






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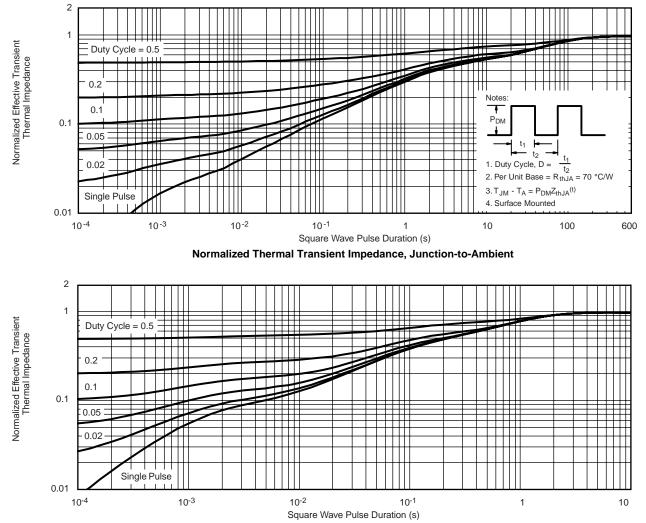
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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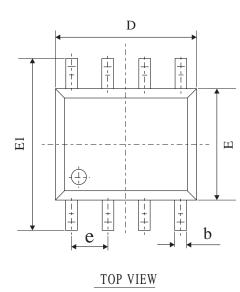
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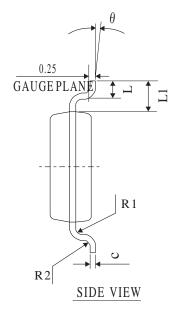


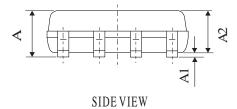
Normalized Thermal Transient Impedance, Junction-to-Foot

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SOP-8 PACKAGE OUTLINE







COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	TYP	MAX
А	1.30	1.60	1.85
A1	0.03	0.15	0.28
A2	1.20	1.45	1.70
b	0.26	0.40	0.54
С	0.132	0.203	0.273
D	4.50	4.90	5.30
Е	3.50	3.00	4.30
E1	5.50	6.00	6.50
L	0.30	0.70	1.10
θ	2°	4°	6°
L1	1.04REF		
e	1.27BSC		
R1	0.07TYP		
R2	0.07TYP		



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